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Giant photoresistivity and optically controlled switching in self-assembled nanowires

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We report the observation of giant photoresistivity in electrochemically self-assembled CdS and ZnSe nanowires electrodeposited in a porous alumina film. The resistance of these nanowires increases by one to two orders of magnitude when exposed to infrared radiation, possibly because of real-space transfer of electrons from the nanowires into the surrounding alumina by photon absorption. This phenomenon has potential applications in “normally on” infrared photodetectors and optically controlled switches. © 2001 American Institute of Physics.

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There is significant current interest in self-assembled semiconductor nanostructures produced by electrodeposition of materials in porous anodic alumina film. They possess intriguing magnetic,¹ electronic² and nonlinear optical properties.³ Here, we report a photoelectric property of these structures that may find application in novel “normally-on” infrared photodetectors. Such photodetectors, which are conductive in the absence of infrared radiation, but insulating in the presence of radiation, have multiple uses. For instance, they can be connected in series with the more conventional normally off photodetectors to create complementary devices in which appreciable photocurrent flows only during the switching on or off of the radiation source. Two broad-band complementary detectors with slightly staggered peak frequencies can also be connected in series to make a narrow band detector.

Regimented arrays of CdS and ZnSe quantum wires were self-assembled by electrodepositing the semiconductor selectively within the pores of a nanoporous alumina film. The alumina film was produced by dc anodization of an aluminum foil in an acid. Anodization in sulfuric acid results in 10 nm diam pores whereas anodization in oxalic acid produces 50 nm diam pores. A raw atomic force micrograph of the top surface of a representative nanoporous alumina film is shown in Fig. 1 where the dark areas are the pores and the surrounding light areas are alumina. Further details of the process of forming the alumina film can be found in Ref. 4.

We have electrodeposited two different compound semiconductors within the pores: CdS and ZnSe. CdS was electrodeposited by immersing the alumina film (along with the aluminum substrate) in an electrolyte consisting of a non-aqueous solution of dimethyl-sulfoxide comprised of 50 mM cadmium perchlorate, 10 mM lithium perchlorate and 10 mM sulfur powder. In the case of ZnSe deposition, cadmium perchlorate is replaced by zinc perchlorate and sulfur powder by selenium powder. Electrodeposition is carried out at 100 °C with an ac signal of 20 V at 250 Hz. During the negative half of the ac cycle, the Cd⁺⁺ or Zn⁺⁺ ions in the

solution are reduced to zero-valent Cd or Zn and are deposited selectively in the pores which offer the least impedance path for the electric current to flow. During the positive cycle, the zero-valent metals are not re-oxidized into the ions since alumina is a valve metal oxide.¹ The high temperature of the solution then allows Cd or Zn in the pores to react with S or Se in the solution to produce CdS or ZnSe. The deposition is made to last a few minutes so that the length of the CdS or ZnSe nanowires within the pores is a few microns. These nanowires are cylindrical with nominal lengths of a few microns and nominal diameters of either 10 or 50 nm.

The nanowires produced by the above method are not directly suitable for current–voltage measurements because they cannot be contacted easily. Particularly bothersome is the presence of an alumina “barrier layer” in contact with the aluminum substrate (see Fig. 1) which presents a large potential barrier to current flow along the wire axis. We therefore carry out a series of steps to remove the barrier layer and make the wires electrically accessible. These steps are shown in Fig. 2. First, the top surface of the sample is etched for a few minutes in 0.2 M H₂CrO₄/0.4 M H₃PO₄ solution. This dissolves the alumina and exposes the top of some of the semiconductor wires. Not all wires are exposed since the wires have varying lengths. A thin coating of Au (10–20 nm) is then applied on the surface, followed by a thick organic layer which provides mechanical strength to the film during later processing steps. The aluminum substrate is then dissolved in HgCl₂ to expose the barrier layer of alumina which is subsequently removed in 5% H₃PO₄ (several minutes of soaking) thereby exposing some of the semiconductor nanowires from the bottom. The sample is flipped over and the bottom layer is coated with 10–20 nm of Au. The final structures are arrays of parallel nanowires with Au ohmic contacts at both ends. Gold wires and silver paint are used to connect the Au contacts to the measuring equipment.

The current–voltage characteristic of 10 nm diam wires (in the presence and absence of IR radiation) is shown in Fig. 3(a). The resistances of all samples increase significantly, by up to a factor of 160, when exposed to IR radiation. This is not a sample heating effect which can only produce a change

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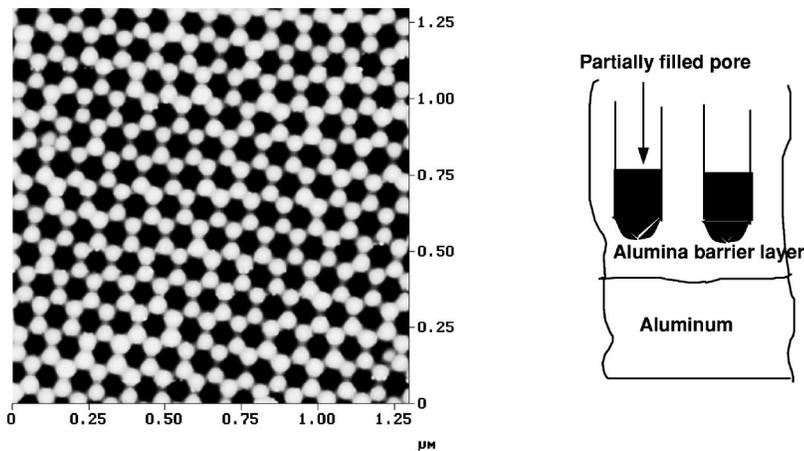


FIG. 1. Raw atomic force micrograph of a porous alumina film produced by anodizing aluminum in oxalic acid. The pore diameter for oxalic acid anodization is ~ 50 nm whereas for sulfuric acid anodization, it is ~ 10 nm. A bright field transmission electron microscope micrograph of the pores for sulfuric acid anodization can be viewed in Fig. 7 of Ref. 4. The dark areas are the pores and the surrounding light areas are alumina. The side view of the porous structure shows the barrier layer.

of a few percent in resistance. In any case, the radiation intensity is low enough to avoid measurable sample heating. In Fig. 3(b), we show the characteristics for a “blank” alumina film (with no semiconductor in it) to ascertain that the photoresistive behavior is indeed due to the semiconductor and not due to the alumina. Note that the alumina shows a weak photoconductivity as opposed to photoresistivity, i.e., the behavior is opposite to that of semiconductors; the conductance is slightly larger, rather than smaller, when the IR radiation is on. The ratio of dark to illuminated current ($I_{\text{dark}}/I_{\text{IR}}$) for 10 and 50 nm diam CdS and ZnSe nanowires is shown in Fig. 3(c) as a function of applied voltage.

The photoresistive behavior described here most likely accrues from photoassisted real-space transfer of electrons from the semiconductor nanowires into traps in the surrounding alumina. The majority of carriers in the semiconductor nanowires are electrons as has been verified in the past by capacitance–voltage spectroscopy.⁵ Many of these electrons absorb infrared photons and are excited to trap levels in the

alumina where they get trapped and can no longer contribute to conduction. As a result, the resistance rises. This process is depicted in Fig. 4(a). It is an indirect process in real space, but the wave functions of electrons in the semiconductors penetrate a short distance into the alumina, thereby making the matrix element of this process significant at the interface between the semiconductor and alumina.

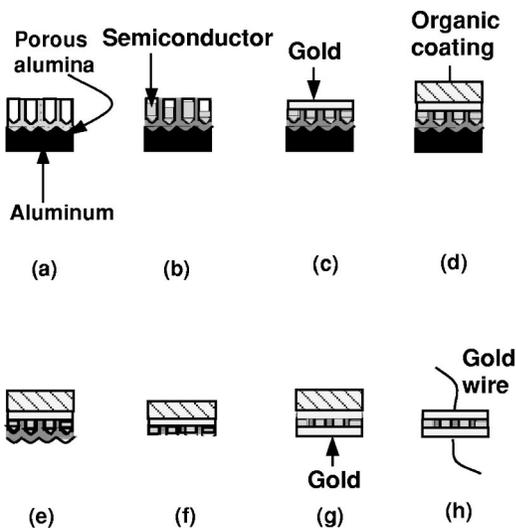


FIG. 2. Steps showing the preparation of nanowire samples for electrical measurement: (a) as-produced porous anodic alumina (template for self-assembling nanowires), (b) pores filled with the semiconductor by electrodeposition, (c) etching of the alumina to expose the tips of some of the wires and then coating gold on top for contact to the top-exposed wires, (d) organic coating to provide mechanical stability of the template during later processing, (e) removal of the aluminum substrate in HgCl_2 , (f) removal of the alumina barrier layer in phosphoric acid, (g) coating of gold to form a back contact, (h) removal of the organic layer in acetone and attaching gold wires (with silver paint) for electrical measurement.

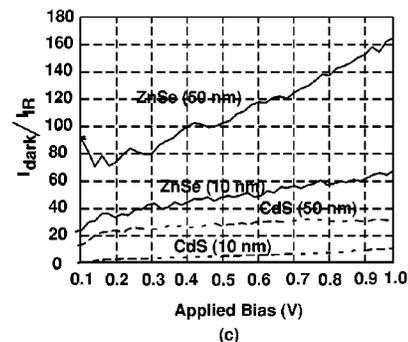
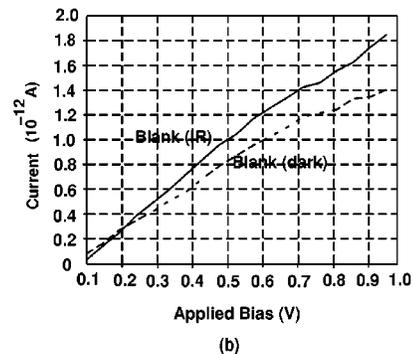
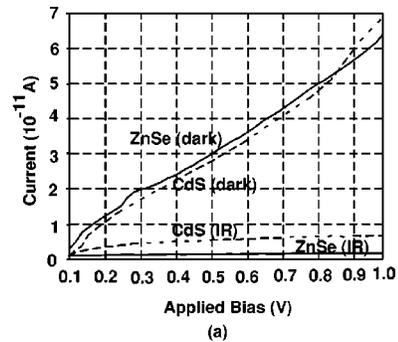


FIG. 3. (a) Current–voltage characteristics of 10 nm diam wires, (b) Current–voltage characteristics of blank alumina templates, and (c) the ratio of dark-to-illuminated current as a function of applied bias.

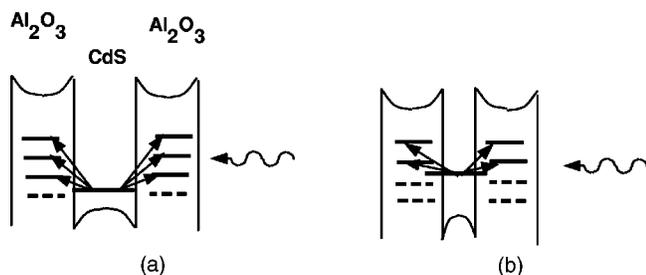


FIG. 4. (a) Energy band diagram explaining photoabsorption of electrons from the semiconductor conduction band into traps in the band gap of alumina. (b) Fewer traps states are available as final states in narrower wires. Traps which are below the lowest subband level in the semiconductor wire (and therefore not accessible as final states) are shown by broken lines.

An interesting feature is that the larger diameter (50 nm) wires show a stronger photoresistive effect (larger ratio of dark-to-illuminated conductance) than the smaller diameter (10 nm) wires. This can be explained within a simple band picture [see Fig. 4(b)]. When the wire is narrower, the subband level in the wire is higher in energy so that fewer trap levels in the insulator are now *above* the subband level and accessible. Thus, fewer carriers can transfer out of the wire into the traps, and the photoresistive effect is weaker. This picture is substantiated by the IR absorption spectra for 10 and 50 nm diam wires shown in Figs. 5(a) and 5(b). The integrated absorption is always much larger for the wider

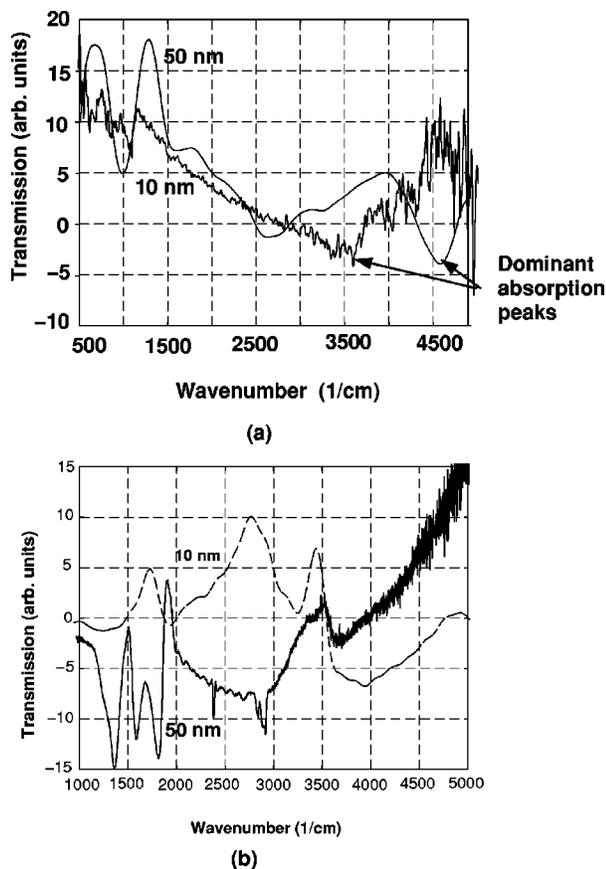


FIG. 5. Infrared absorption spectra in (a) CdS nanowires and (b) ZnSe nanowires. In some cases, the spectrum was smoothed to eliminate spurious interference effects.

diameter wires showing that more trap levels are participating in their case.

Note that if there is a “dominant trap level” causing a dominant absorption peak, then it will be *redshifted* in the narrower wire since the energy separation between the subband level and the trap states *decreases* as the wire gets narrower. The redshift is clearly observed in the CdS wires [Fig. 5(a)] where there is a dominant peak. The spectrum for ZnSe, on the other hand, is much more complex (obviously because of a more complex distribution of traps in energy space) and does not show a dominant peak indicating that there is no single dominant trap level at the ZnSe/Al₂O₃ interface. Little, if anything, is known about trap levels at the interface of electrodeposited semiconductors and anodic alumina. They are probably sensitive to electrodeposition and anodization conditions. There are trap states at the Au–semiconductor interface as well, but this interface is much smaller in area than the interface between the semiconductor and alumina, so these traps are unlikely to have a dominant effect.

In the past, a weak photoresistive effect, for which the conductance dropped by a mere $\sim 10\%$ (as opposed to the 160-fold drop reported here), was observed in *bulk* CdS and ZnSe samples,^{6,7} but was due to an entirely different mechanism. There, electrons were photoexcited by the IR radiation from the valence band into intentionally created empty traps in the band gap. The resulting holes in the valence band recombined with electrons in the conduction band to drop the conductance by 10%. We do not have any intentionally created traps. Furthermore, capacitance voltage spectroscopy has shown⁵ that the trap concentration is small enough in our samples that the Fermi level is completely unpinned. In any case, all traps in the band gap must be filled because we have significant electron concentration in the conduction band, meaning that the Fermi level must be close to the conduction band edge. Thus, our effect cannot be explained by the same mechanism as that in Refs. 6 and 7. That mechanism is a two-step process: photoexcitation of electrons into traps (or, equivalently, photoemission of holes from traps), followed by recombination of those holes with electrons in the conduction band. Ours is a one-step process that only involves trapping and no recombination.

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¹ See, for example, D. AlMawlawi, N. Coombs, and M. Moskowitz, *J. Appl. Phys.* **70**, 4421 (1991).

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⁴ S. Bandyopadhyay and A. E. Miller, in *Handbook of Advanced Electronic and Photonic Materials and Devices*, edited by H. S. Nalwa (Academic, San Diego, 2001), Vol. 6, Chap. 1, pp. 1–27; see also numerous references therein.

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